## **Si4840BDY**

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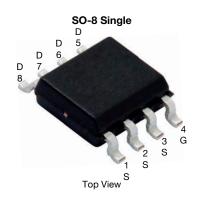
**Vishay Siliconix** 

RoHS

COMPLIANT

HALOGEN

FREE



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	40			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.009			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 4.5 V	0.012			
Q <sub>g</sub> typ. (nC)	15			
I <sub>D</sub> (A)	19 <sup>d</sup>			
Configuration	Single			

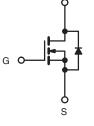
#### **FEATURES**

N-Channel 40 V (D-S) MOSFET

- TrenchFET<sup>®</sup> power MOSFET
- 100 %  $\rm R_g$  and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Synchronous rectification
- POL, IBC
  - Secondary side



N-Channel MOSFET

ORDERING INFORMATION	
Package	SO-8
Lead (Pb)-free	Si4840BDY-T1-E3
Lead (Pb)-free and halogen-free	Si4840BDY-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	40	V	
Gate-source voltage		V <sub>GS</sub>	s ± 20		
	T <sub>C</sub> = 25 °C		19		
Continuous dusin surrent (T 150 °C)	T <sub>C</sub> = 70 °C		15		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	12.4 <sup>a, b</sup>	•	
	T <sub>A</sub> = 70 °C		9.9 <sup>a, b</sup>	— A	
Pulsed drain current		I <sub>DM</sub>	50	-	
Avalanche current		I <sub>AS</sub>	15		
Avalanche energy	L = 0.1 mH	E <sub>AS</sub>	11	mJ	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		5	٨	
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.1 <sup>a, b</sup>	— A	
Maximum power dissipation	T <sub>C</sub> = 25 °C		6		
	T <sub>C</sub> = 70 °C		3.8	w	
	T <sub>A</sub> = 25 °C	PD	2.5 <sup>a, b</sup>	VV	
	T <sub>A</sub> = 70 °C	1	1.6 <sup>a, b</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stq</sub>	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, c	t ≤ 10 s	R <sub>thJA</sub>	37	50	°C/W	
Maximum junction-to-foot (drain)	Steady state	R <sub>thJF</sub>	17	21	-C/W	

#### Notes

a. Surface mounted on 1" x 1" FR4 board

b. t = 10 s

c. Maximum under steady state conditions is 85 °C/W

d. Based on  $T_C = 25 \ ^{\circ}C$ 

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## Si4840BDY

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<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	I			1	1		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	40	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_J$	I <sub>D</sub> = 250 μA	-	40	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$		-	-6	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1	-	3	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V$ , $V_{GS} = \pm 20 V$	-	-	± 100	nA	
Zero gate voltage drain current	IDSS	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA	
	-055	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	5		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50	-	-	A	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12.4 \text{ A}$	-	0.0074	0.0090		
	US(on)	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10.8 \text{ A}$	-	0.0095	0.0120	Ω	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 12.4 A	-	56	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	2000	-		
Output capacitance	C <sub>oss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	260	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	150	-		
	0	$\frac{V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 12.4 \text{ A}}{-}$	33	50			
Total gate charge	Qg		-	15	23	nC	
Gate-source charge	Q <sub>as</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 12.4 A	-	6.7	-		
Gate-drain charge	Q <sub>gd</sub>		-	5.1	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz	-	1.4	2.1	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	25	40		
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 2 \Omega$	-	12	20	1	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, R_g = 1 \Omega$	-	25	40	1	
Fall time	t <sub>f</sub>		-	10	15	1	
Turn-on delay time	t <sub>d(on)</sub>		-	10	15	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{I}} = 2 \Omega$	-	15	25	1	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, R_q = 1 \Omega$	-	30	45	1	
Fall time	t <sub>f</sub>		-	10	15	1	
Drain-Source Body Diode Characteristi	· · ·	I	l			L	
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	30		
Pulse diode forward current	I <sub>SM</sub>	<u> </u>	-	-	50	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 10 A, V <sub>GS</sub> = 0 V	-	0.8	1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	30	60	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	1	-	26	52	nC	
Reverse recovery fall time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$	-	17.5	-		
	•a			17.5		ns	

Notes

a. Pulse test: pulse width  $\leq 300~\mu\text{s},$  duty cycle  $\leq 2~\%$ 

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

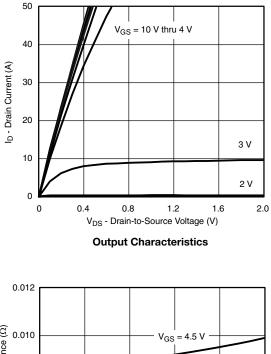
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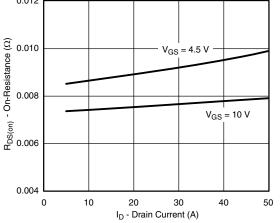
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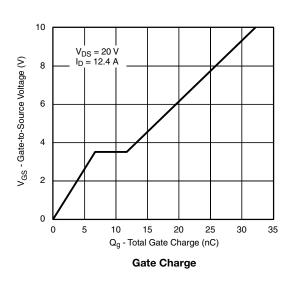
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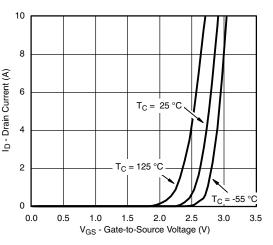
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



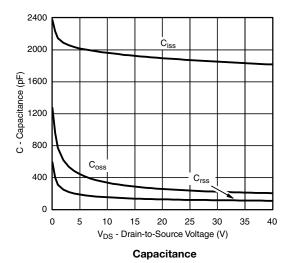


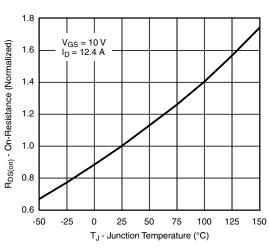
**On-Resistance vs. Drain Current and Gate Voltage** 





**Transfer Characteristics** 





**On-Resistance vs. Junction Temperature** 

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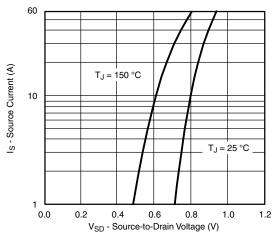
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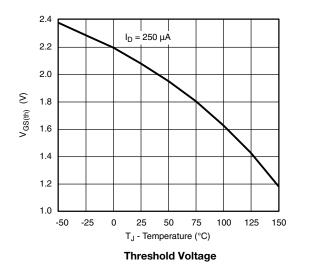
# Si4840BDY

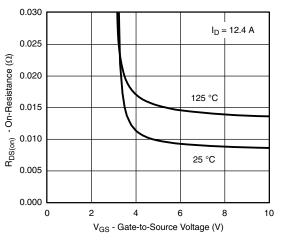
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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

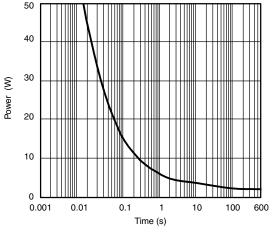


Source-Drain Diode Forward Voltage

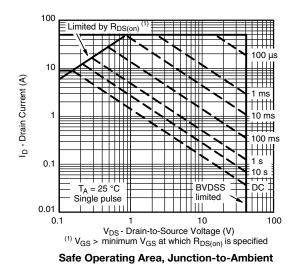




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)



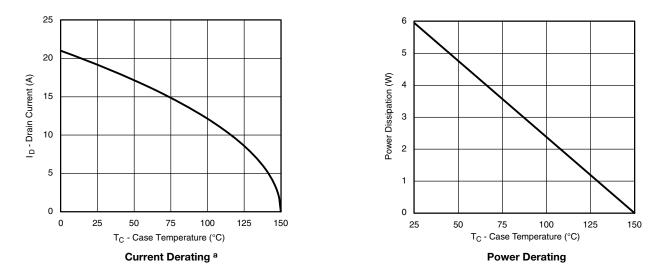
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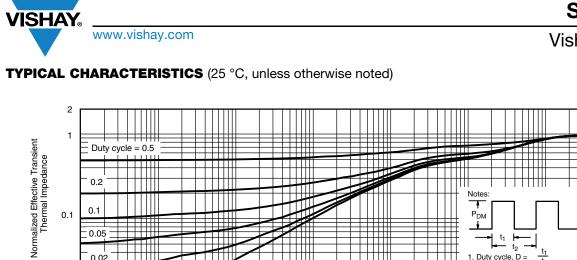
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



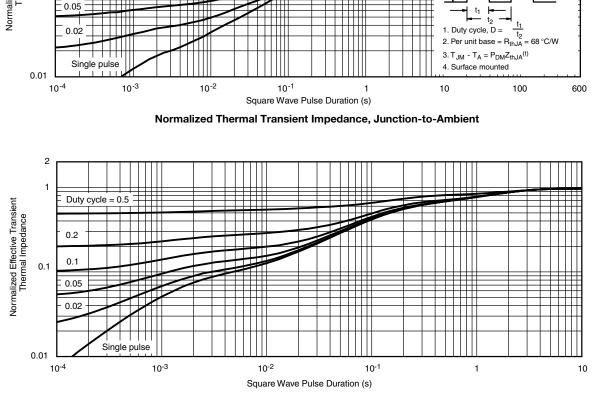
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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Normalized Thermal Transient Impedance, Junction-to-Foot

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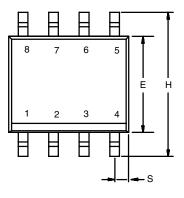


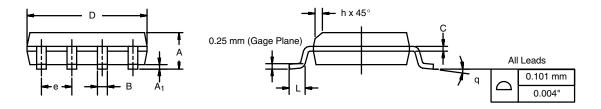
# Package Information

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## SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





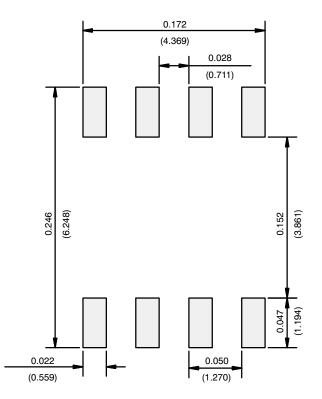
	MILLIMETERS		INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

# **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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